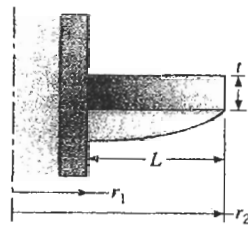


1. A plane wall is a composite of two materials, A and B, with imperfect contact. The wall of material A has volumetric heat generation distribution of $q = q_0 \cos[\pi x/(2L_A)]$ and thermal conductivity of $k_A = 5 \text{ W/mK}$ and thickness $L_A = 5\text{mm}$. Where $q_0 = 1.0 \times 10^8 \text{ W/m}^3$, is a constant. The wall material B has no heat generation with $k_B = 20 \text{ W/mK}$ and thickness $L_B = 1\text{mm}$. The thermal contact resistance between material A and material B for a unit area is $1 \times 10^{-4} \text{ m}^2\text{K/W}$. The inner surface of material A, i.e., $x = 0$, is well insulated, while the outer surface of material B is cooled by a water stream with $T_f = 285 \text{ C}$ and heat transfer coefficient of $10,000 \text{ W/m}^2\text{K}$. Determine the maximum temperature of material A. Show your derivation clearly. (20 %)
2. Consider an annular fin as shown, assume temperature at the fin base is T_b and fin tip is adiabatic, please determine the fin heat transfer rate, fin effectiveness and fin efficiency if the fluid temperature is T_∞ and heat transfer coefficient is h . Show your derivation clearly. (20%)



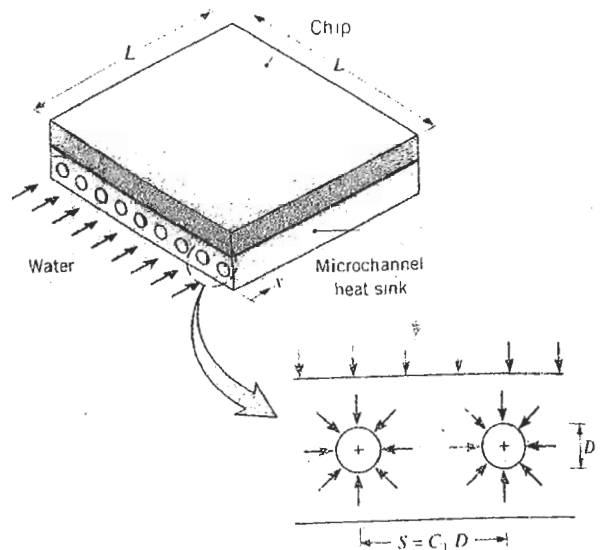
3. A semi-infinite solid wall is initially with uniform temperature T_i . The surface at $x = 0$ is suddenly changed to T_s , a constant, for $t \geq 0$. Determine the transient temperature distribution in the solid wall and heat flux at $x = 0$. Assume the thermal conductivity and thermal diffusivity of the wall material are k and α , respectively. Show your derivation clearly. (20%)

4. A microchannel heat sink with water as the working fluid has been proposed for cooling high performance computer chip as shown. For $L=10$ mm, $D=1$ mm, $C1=2$ and chip power dissipated to the microchannels is 20 W. Assume water temperature at channel inlet is 300 K and the total water flow rate is 0.0010 kg/s, determine the water temperature at outlet and maximum channel wall temperature. The following water properties are given: density (ρ) = 990 kg/m³; specific heat (C_p) = 4.18 kJ/kgK; viscosity (μ) = 5.80×10^{-4} kg/ms, thermal conductivity (k) = 0.640 W/mK.

Hint : $Nu_D = 4.36$ if the flow is laminar;

$Nu_D = 0.023 Re_D^{0.8} Pr^{0.4}$ if the flow is turbulent.

Show your derivation clearly. (20%)



5. Coolant inside a tube is heated by hot outer flow as shown; please determine the coolant temperature at outlet and total heat transfer rate from the outer fluid to the coolant. The inside and outside radii of the tube are r_i and r_o , respectively. The thermal conductivity for the tube wall material is k . Show your derivation clearly. (20%)

